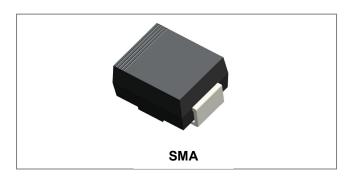






10MQ100N-S SCHOTTKY RECTIFIER



Features

- Small foot print, surface moutable
- Low forward voltage drop
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Circuit Diagram



Applications

- Disk Drives
- Switching power supply
- Redundant power subsystems
- Converters
- Free-Wheeling diodes
- Reverse battery protection
- Battery Charging

Maximum Ratings:

Characteristics	Symbol	Condition	Max.	Units
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	-	100	V
Average Forward Current	I _{F(AV)}	50% duty cycle @T∟=105°C, rectangular wave form	1.5	Α
DC Current	I _{F(DC)}	DC@T∟=120°C	2.1	Α
Peak One Cycle Non-Repetitive Surge Current	I _{FSM}	8.3 ms, half Sine pulse	36	Α

Electrical Characteristics:

Characteristics	Symbol	Condition	Тур.	Max.	Units
Forward Voltage Drop*	V _{F1}	@ 1 A, Pulse, T _J = 25 °C	0.76	0.78	V
		@ 1.5 A, Pulse, T _J = 25 °C	0.79	0.85	V
	V_{F2}	@ 1 A, Pulse, T _J = 125 °C	0.60	0.63	V
		@ 1.5A, Pulse, T _J = 125 °C	0.64	0.68	V
Reverse Current*	I _{R1}	$@V_R = \text{rated } V_R, \text{ Pulse}, \\ T_J = 25 ^{\circ}\text{C}$	0.01	100	uA
	I _{R2}	$@V_R = \text{rated } V_R, \text{ Pulse}, \\ T_J = 125 ^{\circ}\text{C}$	0.009	1	mA
Junction Capacitance	Ст	$@V_R = 5V, T_C = 25 °C$ $f_{SIG} = 1MHz$ 27		38	PF
Typical Series Inductance	Ls	Measured lead to lead 5 mm from package body 2.0 -		nH	
Voltage Rate of Change	dv/dt	-	_	10,000	V/μs

^{*} Pulse width < 300 µs, duty cycle < 2%

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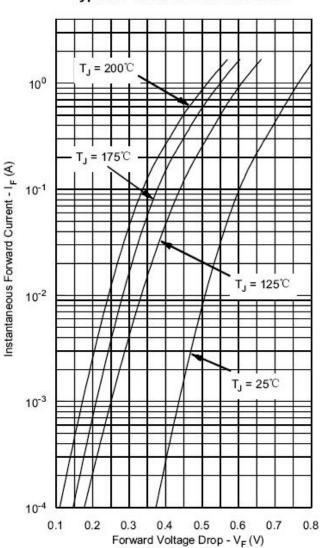


Thermal-Mechanical Specifications:

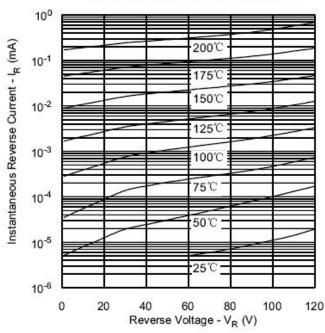
Characteristics	Symbol	Condition	Specification	Units
Junction Temperature	TJ	-	-55 to +150	°C
Storage Temperature	T _{stg}	-	-55 to +150	°C
Typical Thermal Resistance Junction to Ambient	$R_{\theta JA}$	-	80	°C/W
Approximate Weight	wt	-	0.06	g
Case Style	SMA			

Ratings and Characteristics Curves

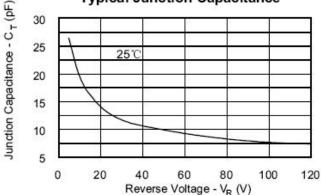
Typical Forward Characteristics



Typical Reverse Characteristics







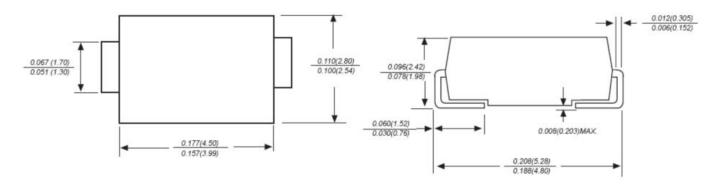
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Mechanical Dimensions SMA(Millimeters/Inches)



Ordering Information

Device	Package	Shipping
10MQ100N-S	SMA (Pb-Free)	5000pcs / reel

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

Marking Diagram

Where XXXXX is YYWWL



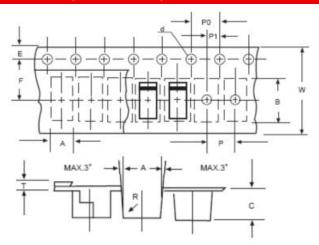
S = Device Type
A = Package Type
1 = Forward Current (1A)
J = Reverse Voltage (100V)
YY = Year

YY = Year WW = Week L = Lot Number

Cautions: Molding resin

Epoxv resin UL:94V-0

Carrier Tape & Reel Specification SMA



SYMBOL	Millimeters		
STIVIBUL	Min.	Max.	
Α	2.97	3.17	
В	5.70	5.90	
С	2.32	2.52	
d	1.40	1.60	
E	1.40	1.60	
F	5.60	5.70	
Р	3.90	4.10	
P0	3.90	4.10	
P1	1.90	2.10	
Т	0.25	0.35	
W	11.80	12.20	

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